

Innovating Energy Technology

FML60N150S2FDHF

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FUJI POWER MOSFET

Super J MOS® S2 series

N-Channel enhancement mode power MOSFET

Features

Pb-free lead terminal RoHS compliant Halogen-free molding compound MSL:1, Reflow available

Applications

For switching



Package and Internal circuit chart

DFN8x8 (Out view: see to 7/8 page)

■ Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Dualin Course Voltage	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} = - 30 V
Continuous Drain Current	,	28.7	Α	Tc=25°C Note*1,2
Continuous Drain Current	l _D	18.2	Α	Tc=100°C Note*1,2
Pulsed Drain Current	I DP	83.6	Α	Note *2
Gate-Source Voltage	V _{GS}	±30	V	
Non-Repetitive Maximum Avalanche Current	<i>I</i> _{AS}	3.5	А	Note *3
Non-Repetitive Maximum Avalanche Energy	E as	517.5	mJ	Note *4
Maximum MOSFET dv/dt	d <i>v</i> ⊳s/d <i>t</i>	50	V/ns	<i>V</i> _{DS} ≤ 600V
Continuous	,	28.7	Α	Tc=25°C Note*1,2
Diode Forward Current	I DR	18.2	Α	Tc=100°C Note*1,2
Pulsed Diode Forward Current	IDRP	83.6	Α	Note *2
Peak Diode Recovery dv/dt	dv/dt	30	V/ns	Note *5
Peak Diode Recovery -didr/dt	-d <i>i</i> _{DR} /d <i>t</i>	100	A/µs	Note *6
Maximum Bower Discination	P _{tot}	159	W	<i>T</i> c=25°C
Maximum Power Dissipation	Ptot	2.78	W	<i>T</i> _a =25°C
Operating Channel Temperature	T_{ch}	150	°C	
Storage Temperature	T _{stg}	-55 to +150	°C	

Note *1 : Maximum duty cycle D=0.55

Note *1: Maximum duty cycle D=0.50Note *2: Limited by maximum channel temperature. Note *3: $T_{ch} \le 150$ °C, See Figure 1 and 2. Note *4: Starting $T_{ch} = 25$ °C, $I_{AS} = 2.1$ A, L = 215 mH, $V_{DD} = 60$ V, $R_{G} = 50$ Ω , See Figure 1 and 2. Eas limited by maximum channel temperature and avalanche current.

Note *5 : $l_{DR} \le 22.7 \text{ A}$, $-d_{IDR}/dt \le 100 \text{ A}/\mu_{S}$, V_{DS} peak $\le 600 \text{ V}$, $T_{Ch} \le 150 ^{\circ}\text{C}$. Note *6 : $l_{DR} \le 22.7 \text{ A}$, $d_{V}/dt \le 30 \text{ V/ns}$, V_{DS} peak $\le 600 \text{ V}$, $T_{Ch} \le 150 ^{\circ}\text{C}$.

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■ Electrical Characteristics at T_c =25°C (unless otherwise specified) • Static characteristics

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{es} = 0 V I _D = 250 μA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$ $I_D = 3.5 \text{ mA}$		3.0	4.0	5.0	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 600 V V _{GS} = 0 V	T _{ch} = 25 °C	-	-	25	μА
		V _{DS} = 480 V V _{GS} = 0 V	T _{ch} = 125 °C	-	-	250	
Gate-Source Leakage Current	IGSS	V _{DS} = 0 V V _{GS} = ± 30 V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{cs} = 10 V I _D = 5.7 A		-	0.134	0.150	Ω
Gate resistance	r _g	f = 1 MHz, open drain		-	8.3	_	Ω

• Dynamic characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	g fs	$V_{DS} = 25 \text{ V}$ $I_D = 11.4 \text{ A}$	4	16	-	S
Input Capacitance	Ciss	V _{DS} = 400 V	-	1190	-	
Output Capacitance	Coss	V _{GS} = 0 V	-	42	-	
Reverse Transfer Capacitance	Crss	f = 250 kHz	-	5.8	-	
Effective output capacitance, energy related (Note *7)	C _{o(er)}	V _{DS} = 0400 V V _{GS} = 0 V	-	103	-	pF
Effective output capacitance, time related (Note *8)	C _{o(tr)}	V _{DS} = 0400 V V _{GS} = 0 V I _D = constant	-	410	-	
Turn-On Time	t _{d(on)}		-	41	-	
Turn-On Time	t r	$V_{\text{GS}} = 10 \text{ V}$ $V_{\text{D}} = 11.4 \text{ A}$	-	38	-	
Turn-Off Time	t _{d(off)}	$R_{\rm G} = 33 \Omega$	-	198	-	ns
	t f	See Figure 3 and 4	-	21	-	
Total Gate Charge	Q _G	$V_{DD} = 400 \text{ V}$	-	59	-	
Gate-Source Charge	Q _{GS}	$V_{\text{GS}} = 10 \text{ V}$ $I_{\text{D}} = 22.7 \text{ A}$	-	25	-	nC
Gate-Drain Charge	Q GD	See Figure 5	-	34	-	

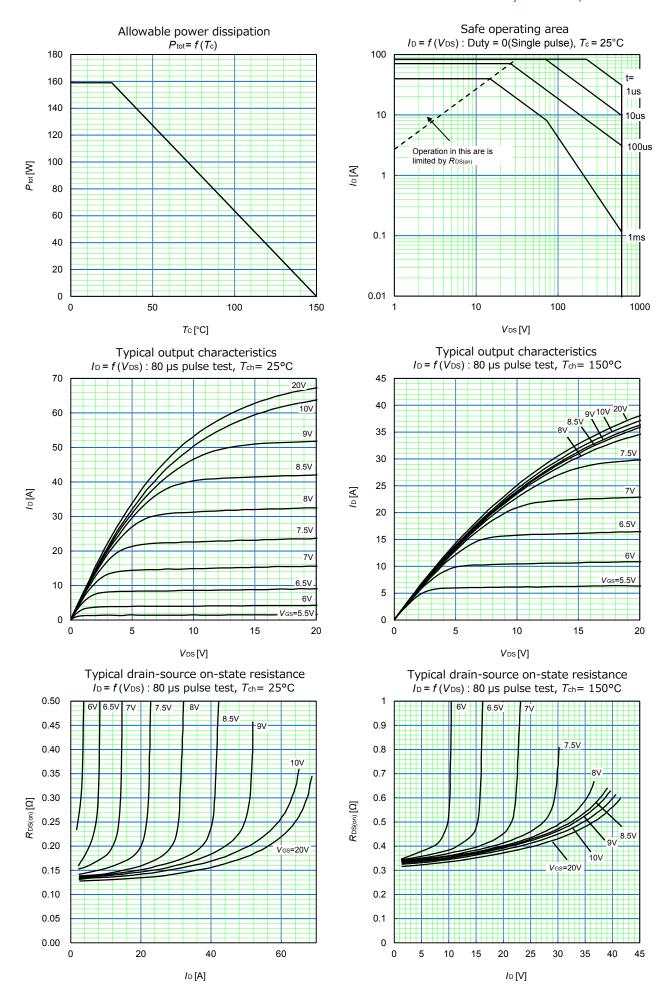
Note *7 : $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400 V. Note *8 : $C_{\text{o(er)}}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400 V.

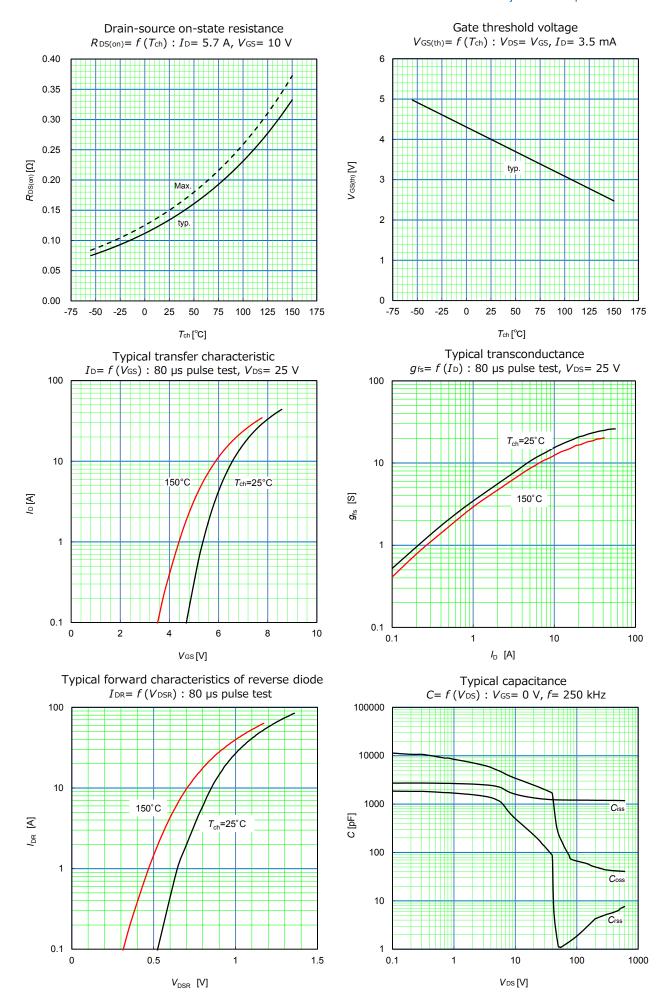
• Reverse diode characteristics

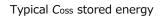
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	V _{DSR}	I _{DR} = 22.7 A, V _{GS} = 0 V T _{ch} = 25 °C	-	1.00	1.35	V
Reverse Recovery Time	t rr	$V_{\text{DD}} = 400 \text{ V}$ $I_{\text{DR}} = 22.7 \text{ A}$ $V_{\text{GS}} = 0 \text{ V}$ $-d_{\text{Inr}}/dt = 100 \text{ A/}\mu\text{s}$ $T_{\text{ch}} = 25 \text{ °C}$ See Figure 6 and 7	-	160	-	ns
Reverse Recovery Charge	Qrr		-	1.2	-	μC
Peak Reverse Recovery Current	I _{rrm}		-	14.5	-	А

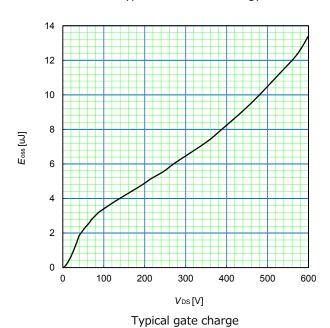
■ Thermal Resistance

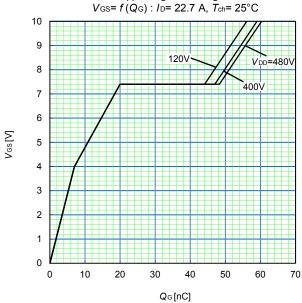
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Channel – Ambient	R _{th(ch-a)}	Device mounted on PCB (FR4) Size:40mm*40mm*1.5mm with 6cm² copper area (one layer, 70µm thickness) for drain connection and cooling.	-	-	45	°C/W
Thermal Resistance, Channel – Case	R _{th(ch-c)}		-	-	0.786	°C/W



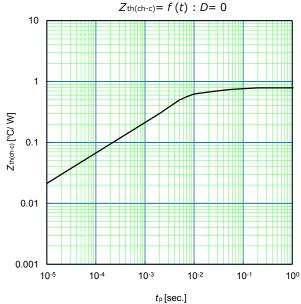




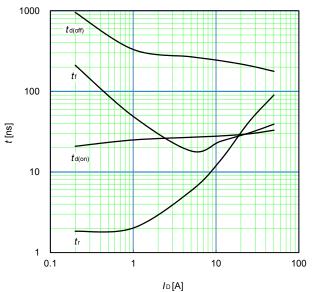




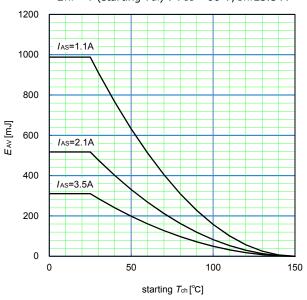
Transient Thermal Impedance



Typical switching times vs. I_D t= $f(I_D)$: V_{DD} = 400 V, V_{GS} = 10 V/0 V, V_{CS} = 24 Ω , V_{Ch} = 25°C



Maximum Avalanche Energy $E_{\text{AV}} = f \text{ (starting } T_{\text{ch}}) : V_{\text{DD}} = 60 \text{ V}, I_{\text{AV}} \leq 3.5 \text{ A}$



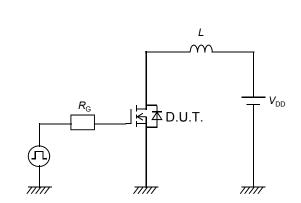


Figure 1. Unclamped inductive load test circuit

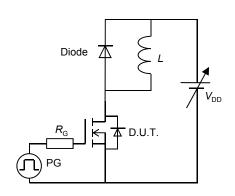


Figure 3. Switching test circuit

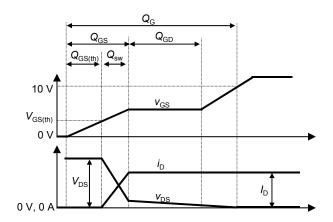


Figure 5. Gate charge waveform

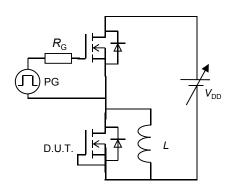


Figure 6. Diode reverse recovery test circuit

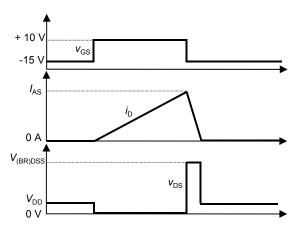


Figure 2. Unclamped inductive waveform

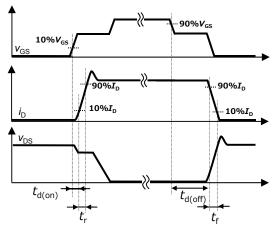


Figure 4. Switching times waveform

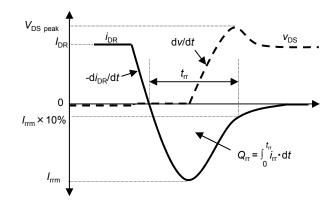
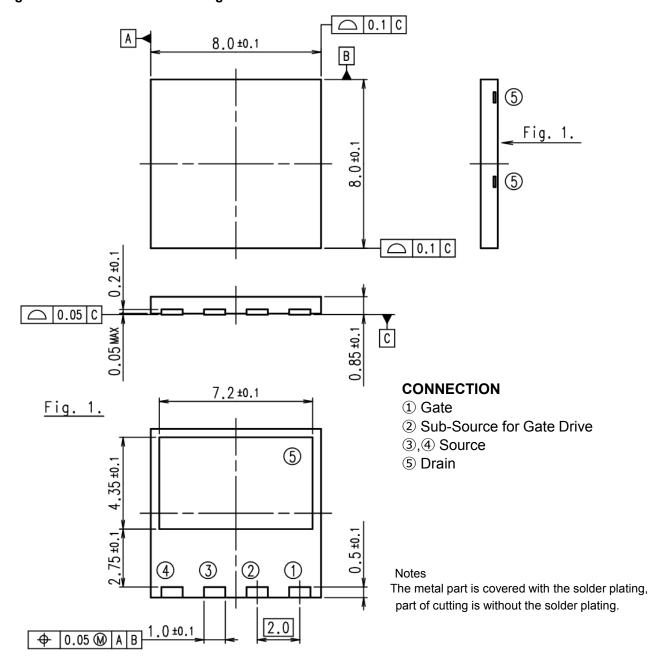
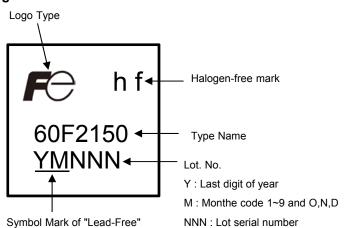


Figure 7. Diode reverse recovery waveform

■ Package Dimensions : DFN8x8 Package

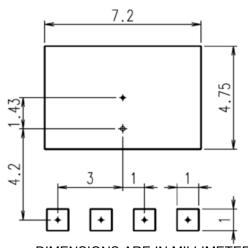


Marking



^{*} The font (font type,size) and the trademark-size might be actually different.

■ Recommended footprint



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